IAP20 Rec'e FCTVFTO 08 MAR 2006.

INFORMATION DISCLOSURE STATEMENT BY APPLICANT PTO FORM 1449	Atty. Docket No. 10191/4346  Serial No. To Be Assigned  101571246			
	Applicant(s) Joachim RUDHARD			
	Filing Date Herewith	Group To Be Assigned		

## **U. S. PATENT DOCUMENTS**

EXAMINER'S	PATENT	PATENT	NAME	CLASS	SUBCLASS	FILING
INITIALS	NUMBER	DATE				DATE
	6,198,098*	March 6, 2001	Laou			
	6,210,988*	April 3, 2001	Franke et al.			

## FOREIGN PATENT DOCUMENTS

EXAMINER'S INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB-CLASS	TRANSLAT	`ION
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## OTHER DOCUMENTS

EXAMINER'S INITIALS		AUTHOR, TITLE, DATE, PERTINENT	•		
**************************************	000000000000000000000000000000000000000	Tillack B. et al; MONITORING OF DEPOSITION AND DRY ETCHING OF SI/SIGE MULTIPLE STACKS; Journal of Vacuum Science And Technology: Part B, American Institute Of Physics, New York, US.*  Premachandran C S et al: A NOVEL Provide CALLY CONDUCTIVE WAFER THROUGH HOLD FILLED VIAS			
		Premachandran C S et al; A NOVEL ECCEPTICALLY CONDUCTIVE WAFER THROUGH HOLD FILLED VIAS INTERCONNECT FOR 3D MEMS PACKAGING; 2003 Proceedings 39, Electronic Components And Technology Conference.*			
EXAMINER		Ming Hung/	DATE CONSIDERED 04/29/2008		
EXAMINER: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.					

<sup>\*</sup>Copy of reference is not enclosed because reference is cited in Search Report (copy of reference provided by International Searching Authority).